

MOSFET

650V CoolMOS™ CFD7A SJ Power Device

650V CoolMOS™ CFD7A is Infineon's latest generation of market leading automotive qualified high voltage CoolMOS™ MOSFETs. In addition to the well-known attributes of high quality and reliability required by the automotive industry, the new CoolMOS™ CFD7A series provides for an integrated fast body diode and can be used for PFC and resonant switching topologies like the ZVS phase-shift full-bridge and LLC.

Features

- \bullet Latest 650V automotive qualified technology with integrated fast body diode on the market featuring ultra low Q_{rr}
- Lowest FOM R_{DS(on)}*Q_g and R_{DS(on)}*E_{oss}
- 100% avalanche tested
- Best-in-class R_{DS(on)} in SMD and THD packages

Benefits

- Optimized for higher battery voltages up to 475 V thanks to further improved robustness
- Lower switching losses enabling higher switching frequencies
- · High quality and reliability
- Increased efficiency in light load and full load conditions

Potential applications

Suitable for PFC and DC-DC stages for:

- Unidirectional and bidirectional DC-DC converters,
- On-Board battery Chargers

Product validation

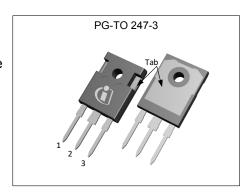
Qualified according to AEC Q101

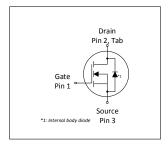
Please note: For production part approval process (PPAP) release we propose to share application related information during an early design phase to avoid delays in PPAP release. Please contact Infineon sales office.



| Parameter | Value | Unit | |
|--------------------------------|-------|------|--|
| V_{DS} | 650 | V | |
| R _{DS(on),max} | 35 | mΩ | |
| $Q_{g,typ}$ | 145 | nC | |
| I _{D,pulse} | 304 | A | |
| E _{oss} @ 400V | 18.4 | μJ | |
| Body diode di _F /dt | 1300 | A/µs | |

| Type / Ordering Code | Package | Marking | Related Links |
|----------------------|------------|----------|----------------|
| IPWS65R035CFD7A | PG-TO247-3 | 65A035F7 | see Appendix A |













650V CoolMOS™ CFD7A SJ Power Device IPWS65R035CFD7A



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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 Maximum ratings

| Davamatar | Cumbal | | Value | s | l lmi4 | Note / Test Condition |
|--|-----------------------|------|-------|----------|--------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Continuous drain current ¹⁾ | I _D | - | - | 63 40 | А | T _C =25°C T _C =100°C |
| Pulsed drain current ²⁾ | I _{D,pulse} | - | - | 304 | Α | T _C =25°C |
| Avalanche energy, single pulse | E AS | - | - | 358 | mJ | I _D =7.3A; V _{DD} =50V; see table 10 |
| Avalanche current, single pulse | I _{AS} | - | - | 7.3 | Α | - |
| MOSFET dv/dt ruggedness | dv/dt | - | - | 120 | V/ns | V _{DS} =0400V |
| Gate source voltage (static) | V _{GS} | -20 | - | 20 | V | static; |
| Gate source voltage (dynamic) | V _{GS,pulse} | -30 | - | 30 | V | f _{repetition} <=100kHz, t _{pulse} <= 2ns |
| Power dissipation | P _{tot} | - | - | 305 | W | <i>T</i> _C =25°C |
| Storage temperature | $T_{ m stg}$ | -55 | - | 150 | °C | - |
| Operating junction temperature | T _j | -40 | - | 150 | °C | - |
| Mounting torque | - | - | - | 60 | Ncm | M3 and M3.5 screws |
| Continuous diode forward current | I _S | - | - | 63 | Α | <i>T</i> _C =25°C |
| Diode pulse current ²⁾ | I _{S,pulse} | - | - | 304 | Α | <i>T</i> _C =25°C |
| Reverse diode dv/dt ³⁾ | dv/dt | - | - | 70 | V/ns | V_{DS} =0400V, I_{SD} <=35.8A, T_{j} =25°C see table 8 |
| Maximum diode commutation speed | di _F /dt | - | - | 1300 | A/μs | V_{DS} =0400V, I_{SD} <=35.8A, T_{j} =25°C see table 8 |

 $^{^{1)}}$ Limited by $T_{j\;max}.$ $^{2)}$ Pulse width t_p limited by $T_{j,max}$ $^{3)}$ Identical low side and high side switch with identical $R_{\rm G}$

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2 Thermal characteristics

Table 3 Thermal characteristics

| Davamatav | Values | | | | l lmi4 | Note / Test Condition | |
|--|-------------------|------|------|------|--------|-------------------------------------|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Thermal resistance, junction - case | R _{thJC} | - | - | 0.41 | °C/W | - | |
| Soldering temperature, wavesoldering only allowed at leads | T _{sold} | - | - | 260 | °C | 1.6mm (0.063 in.) from case for 10s | |

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3 Electrical characteristics

at T_i =25°C, unless otherwise specified

Table 4 Static characteristics

For applications with applied blocking voltage > 475 V, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon.

| Parameter | Combal | | Values | | | Nata / Tank Oam distant |
|--------------------------------------|----------------------|------|----------------|-------|------|---|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 650 | - | - | V | V_{GS} =0V, I_D =1mA |
| Gate threshold voltage ¹⁾ | $V_{(GS)th}$ | 3.5 | 4 | 4.5 | V | $V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=1.79{\rm mA}$ |
| Zero gate voltage drain current | I _{DSS} | - | - 160 | 1 - | μΑ | V _{DS} =650V, V _{GS} =0V, T _j =25°C V _{DS} =650V, V _{GS} =0V, T _j =150°C |
| Gate-source leakage current | I _{GSS} | - | - | 0.1 | μΑ | V _{GS} =20V, V _{DS} =0V |
| Drain-source on-state resistance | R _{DS(on)} | - | 0.029 0.064 | 0.035 | Ω | V _{GS} =10V, I _D =35.8A, T _j =25°C V _{GS} =10V, I _D =35.8A, T _j =150°C |
| Gate resistance | R _G | - | 3.8 | - | Ω | f=250kHz, open drain |

Table 5 Dynamic characteristics

External parasitic elements (PCB layout) influence switching behavior significantly.

Stray inductances and coupling capacitances must be minimized.

For layout recommendations please use provided application notes or contact Infineon sales office.

| Paramatan. | 0 | Values | | | 1114 | | |
|--|--------------------|--------|------|------|------|--|--|
| Parameter | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition | |
| Input capacitance | Ciss | - | 7149 | - | pF | V _{GS} =0V, V _{DS} =400V, f=250kHz | |
| Output capacitance | Coss | - | 95 | - | pF | V _{GS} =0V, V _{DS} =400V, f=250kHz | |
| Effective output capacitance, energy related ²⁾ | C _{o(er)} | - | 230 | - | pF | V _{GS} =0V, V _{DS} =0400V | |
| Effective output capacitance, time related ³⁾ | C _{o(tr)} | - | 2427 | - | pF | I_D =constant, V_{GS} =0V, V_{DS} =0400V | |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 54 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9 | |
| Rise time | t _r | - | 13 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9 | |
| Turn-off delay time | $t_{ m d(off)}$ | - | 159 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9 | |
| Fall time | t _f | - | 3 | - | ns | $V_{\rm DD}$ =400V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =35.8A, $R_{\rm G}$ =1.8 Ω ; see table 9 | |

¹⁾ We do not recommend using the CoolMOS mentioned in this datasheet to operate in "linear mode". For assessment of potential "linear mode", please contact Infineon sales office.

 $^{^{2)}}$ $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400V $^{3)}$ $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400V

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 Table 6
 Gate charge characteristics

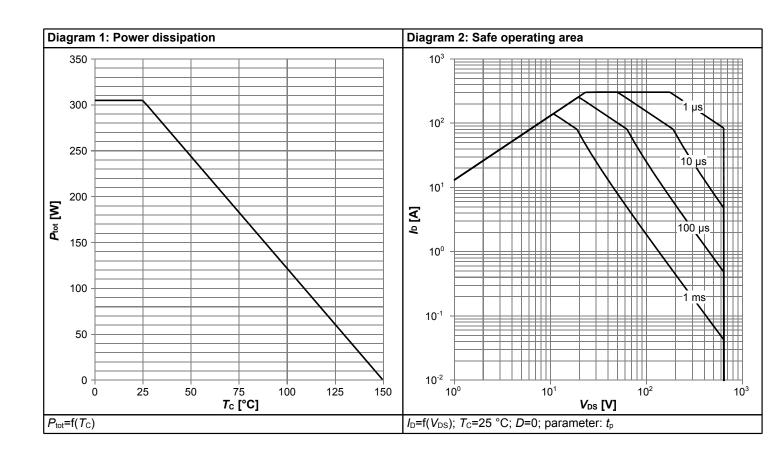
| Parameter | Cumbal | Values | | | Unit | Note / Test Condition |
|-----------------------|----------------------|--------|------|------|------|--|
| | Symbol | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Gate to source charge | Q _{gs} | - | 41 | - | nC | V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V |
| Gate to drain charge | Q_{gd} | - | 44 | - | nC | V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V |
| Gate charge total | Qg | - | 145 | - | nC | V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V |
| Gate plateau voltage | V _{plateau} | - | 5.7 | - | V | V_{DD} =400V, I_{D} =35.8A, V_{GS} =0 to 10V |

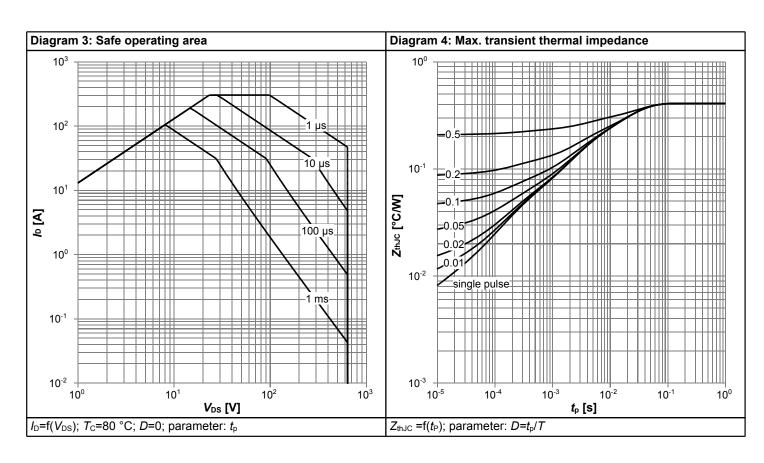
Table 7 Reverse diode characteristics

| Davamatav | Symbol | Values | | | 11 | Nata / Tank Candition |
|-------------------------------|------------------------|--------|------|------|------|--|
| Parameter | | Min. | Тур. | Max. | Unit | Note / Test Condition |
| Diode forward voltage | V _{SD} | - | 1.1 | - | V | V _{GS} =0V, I _F =35.8A, T _j =25°C |
| Reverse recovery time | t _{rr} | - | 208 | - | ns | V_R =400V, I_F =35.8A, d_F/dt =100A/ μ s; see table 8 |
| Reverse recovery charge | Qrr | - | 1.6 | - | μC | V_R =400V, I_F =35.8A, di_F/dt =100A/ μ s; see table 8 |
| Peak reverse recovery current | I _{rrm} | - | 13.1 | - | А | V_R =400V, I_F =35.8A, di_F/dt =100A/ μ s; see table 8 |

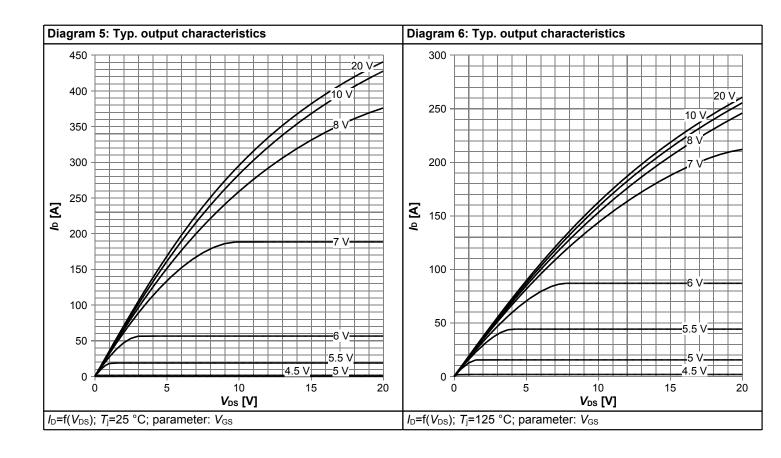


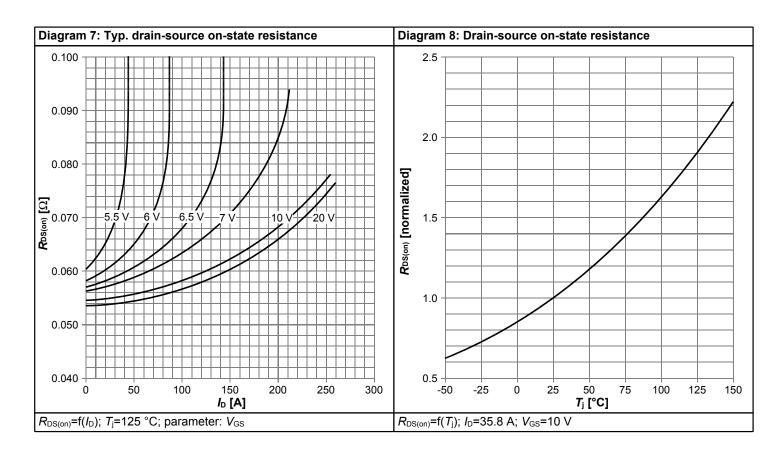
4 Electrical characteristics diagrams



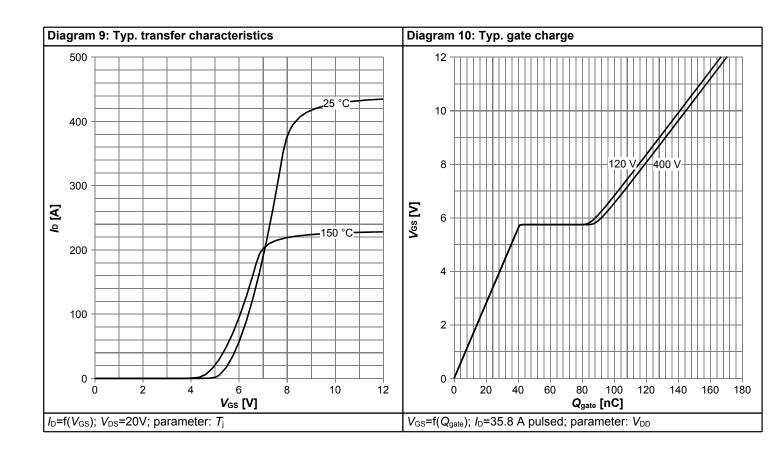


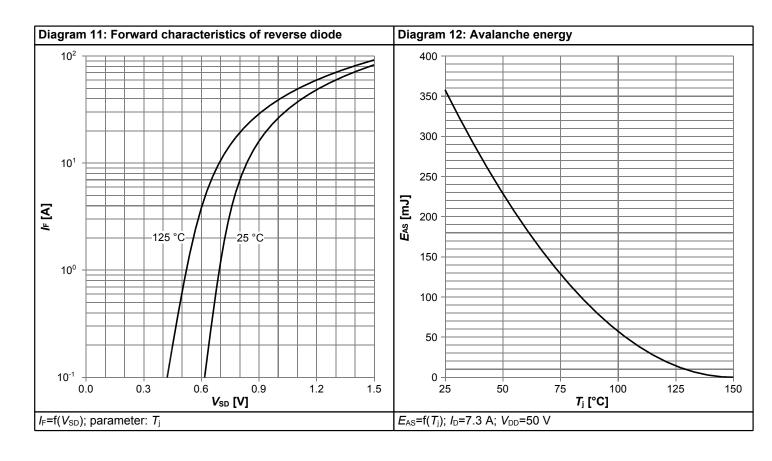




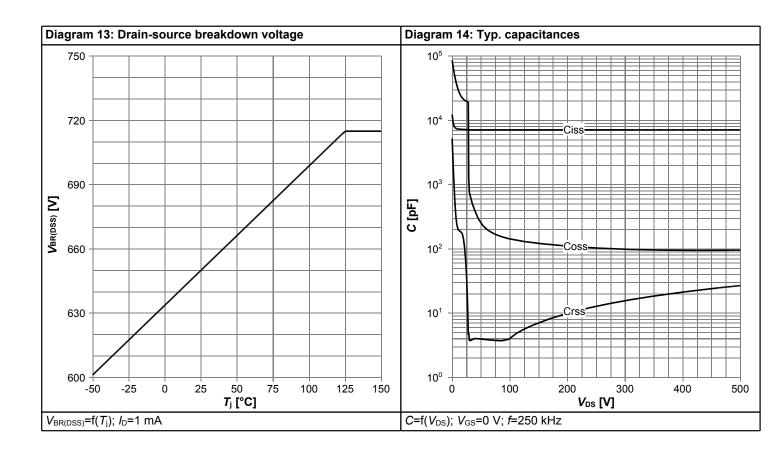


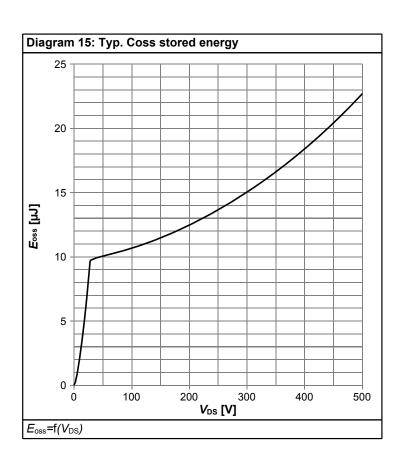
















5 Test Circuits

Table 8 Diode characteristics

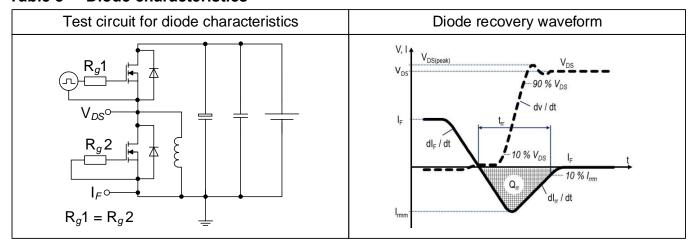


Table 9 Switching times

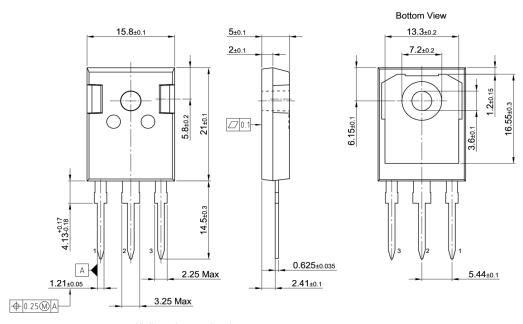


Table 10 Unclamped inductive load





6 Package Outlines



PG-TO247-3-31 Z8B00198400 Rev. 01

Figure 1 Outline PG-TO247-3, dimensions in mm

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7 Appendix A

Table 11 Related Links

• IFX CoolMOS CFD7A Webpage: www.infineon.com

• IFX CoolMOS CFD7A application note: www.infineon.com

• IFX CoolMOS CFD7A simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

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Revision History

IPWS65R035CFD7A

Revision: 2021-11-18, Rev. 2.1

Previous Revision

| 1 To Troub T Control of T | | | | | | | | |
|---------------------------|---|--|--|--|--|--|--|--|
| Revision | Date Subjects (major changes since last revision) | | | | | | | |
| 2.0 | 2020-06-08 | Release of final version | | | | | | |
| 2.1 | 2021-11-18 | Change of wording regarding breakdown voltage / cosmic ray | | | | | | |

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Final Data Sheet 14 Rev. 2.1, 2021-11-18